

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("6576540").PN.	USPAT	OR	OFF	2005/04/05 16:51
L2	1	"5946590".PN.	USPAT; USOCR	OR	ON	2005/04/05 16:50
L3	1	"5565379".PN.	USPAT; USOCR	OR	ON	2005/04/05 16:50
L4	1	"5508229".PN.	USPAT; USOCR	OR	ON	2005/04/05 16:51
L5	1	1 and (package or substrate or copper or seed or gold or nickel or photo or resist or trench or recess or circuit or area or exposing or exposed or base or plate or plating or carrier or pattern or patterned or electroplate or etch or etching or mask or hard or away or metal or material or insulating or thickness or micrometers or solder)	USPAT	OR	ON	2005/04/05 17:11
L6	1	2 and (package or substrate or copper or seed or gold or nickel or photo or resist or trench or recess or circuit or area or exposing or exposed or base or plate or plating or carrier or pattern or patterned or electroplate or etch or etching or mask or hard or away or metal or material or insulating or thickness or micrometers or solder)	USPAT	OR	ON	2005/04/05 17:03
L7	1	3 and (package or substrate or copper or seed or gold or nickel or photo or resist or trench or recess or circuit or area or exposing or exposed or base or plate or plating or carrier or pattern or patterned or electroplate or etch or etching or mask or hard or away or metal or material or insulating or thickness or micrometers or solder)	USPAT	OR	ON	2005/04/05 17:05

L8	1	4 and (package or substrate or copper or seed or gold or nickel or photo or resist or trench or recess or circuit or area or exposing or exposed or base or plate or plating or carrier or pattern or patterned or electroplate or etch or etching or mask or hard or away or metal or material or insulating or thickness or micrometers or solder)	USPAT	OR	ON	2005/04/05 17:20
L9	2	(electroplating adj copper) and (etching adj hard adj mask) and (patterned adj photoresist) and gold	USPAT	OR	ON	2005/04/05 17:09
L10	2	9 and (package or substrate or copper or seed or gold or nickel or photo or resist or trench or recess or circuit or area or exposing or exposed or base or plate or plating or carrier or pattern or patterned or electroplate or etch or etching or mask or hard or away or metal or material or insulating or thickness or micrometers or solder)	USPAT	OR	ON	2005/04/05 17:11
L11	257	438/671	USPAT	OR	ON	2005/04/05 17:21
L12	425	438/686	USPAT	OR	ON	2005/04/05 17:21
L13	1822	438/687	USPAT	OR	ON	2005/04/05 17:21
L14	2836	438/622	USPAT	OR	ON	2005/04/05 17:21
L15	1668	438/612	USPAT	OR	ON	2005/04/05 17:21
L16	1542	438/613	USPAT	OR	ON	2005/04/05 17:22
L17	748	438/734	USPAT	OR	ON	2005/04/05 17:22
L18	451	438/735	USPAT	OR	ON	2005/04/05 17:22
L19	303	438/736	USPAT	OR	ON	2005/04/05 17:22
L20	972	438/738	USPAT	OR	ON	2005/04/05 17:22
L21	257	438/739	USPAT	OR	ON	2005/04/05 17:22
L22	543	438/740	USPAT	OR	ON	2005/04/05 17:22
L23	1472	438/745	USPAT	OR	ON	2005/04/05 17:22
L24	192	438/942	USPAT	OR	ON	2005/04/05 17:22
L25	29	438/943	USPAT	OR	ON	2005/04/05 17:23
L26	1137	438/455	USPAT	OR	ON	2005/04/05 17:23
L27	631	438/584	USPAT	OR	ON	2005/04/05 17:23
L28	519	438/589	USPAT	OR	ON	2005/04/05 17:23
L29	1236	438/597	USPAT	OR	ON	2005/04/05 17:23
L30	2824	438/106	USPAT	OR	ON	2005/04/05 17:23

L31	744	438/770	USPAT	OR.	ON	2005/04/05 17:23
-----	-----	---------	-------	-----	----	------------------